

74LVX3L383 10-Bit Low Power Bus-Exchange Switch

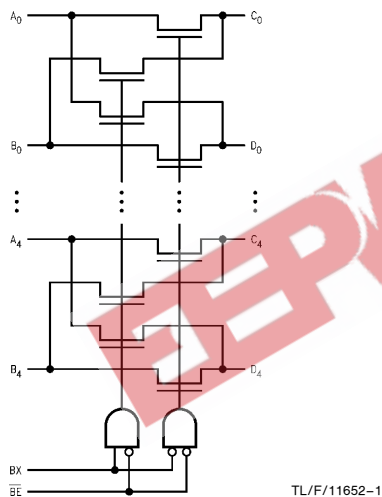
General Description

The LVX3L383 provides two sets of high-speed CMOS TTL-compatible bus switches. The low on resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise. The device operates as a 10-bit bus switch or a 5-bit bus exchanger. The bus exchange (BX) signal provides nibble swapping of the AB and CD pairs of signals. This exchange configuration allows byte swapping of buses in systems. It can also be used as a quad 2-to-1 multiplexer and to create low delay barrel shifters. The bus enable ($\overline{BE}$) signal turns the switches on.

Features

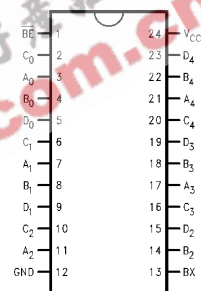
- 5Ω switch connection between two ports
- Zero propagation delay
- Ultra low power with 0.2 μA typical I_{CC}
- Zero ground bounce in flow-through mode
- Control inputs compatible with TTL level
- Available in SOIC, TSSOP and QSOP (SSOP, 0.15" body width) packages

Logic Diagram



Connection Diagram

Pin Assignment for
SOIC, QSOP and TSSOP



Truth Table

$\overline{BE}$	BX	A ₀ –A ₄	B ₀ –B ₄	Function
H	X	High-Z State	High-Z State	Disconnect
L	L	C ₀ –C ₄	D ₀ –D ₄	Connect
L	H	D ₀ –D ₄	C ₀ –C ₄	Exchange

Pin Names	Description
$\overline{BE}$	Bus Switch Enable
BX	Bus Exchange
A ₀ –A ₄ , B ₀ –B ₄	Buses A, B
C ₀ –C ₄ , D ₀ –D ₄	Buses C, D

	SOIC JEDEC	QSOP	TSSOP
Order Number	74LVX3L383WM 74LVX3L383WMX	74LVX3L383QSC 74LVX3L383QSCX	74LVX3L383MTC 74LVX3L383MTCX
See NS Package Number	M24B	MQA24	MTC24

TRI-STATE® is a registered trademark of National Semiconductor Corporation.

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V_{CC})	−0.5V to +7.0V
DC Switch Voltage (V_S)	−0.5V to +7.0V
DC Input Voltage (V_I) (Note 2)	−0.5V to +7.0V
DC Input Diode Current (I_{IN}) with $V_I < 0$	−20 mA
DC Output (I_O) Sink Current	120 mA
Storage Temperature Range (T_{STG})	−65°C to +150°C
Power Dissipation	0.5W

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions

Supply Voltage (V_{CC})	4.0V to 5.5V
Free Air Operating Temperature (T_A)	−40°C to +85°C

DC Electrical Characteristics

Symbol	Parameter	V _{CC} (V)	74LVX3L383			Units	Conditions
			T _A = −40°C to +85°C				
			Min	Typ (Note 5)	Max		
V _{IK}	Maximum Clamp Diode Voltage	4.75			−1.2	V	I _{IN} = −18 mA
V _{IH}	Minimum High Level Input Voltage	4.75–5.25	2.0			V	
V _{IL}	Maximum Low Level Input Voltage	4.75–5.25			0.8		
I _{IN}	Maximum Input Leakage Current	0			10	μA	0 ≤ V _{IN} ≤ 5.25V
		5.25			± 1		
I _{OZ}	Maximum TRI-STATE® I/O Leakage	5.25			± 10	μA	0 ≤ A, B ≤ V _{CC}
I _{OS}	Short Circuit Current	4.75	100			mA	V _I (A), V _I (B) = 0V, V _I (B), V _I (A) = 4.75V
R _{ON}	Switch On Resistance (Note 3)	4.75	5		7	Ω	V _I = 0V, I _{ON} = 30 mA
			10		15	Ω	V _I = 2.4V, I _{ON} = 15 mA
I _{CC}	Maximum Quiescent Supply Current	5.25		0.2	10	μA	V _I = V _{CC} , GND I _O = 0
ΔI _{CC}	Increase in I _{CC} per Input (Note 4)	5.25			2.5	mA	V _{IN} = 3.15V, I _O = 0 Per Control Input

Note 3: Measured by voltage drop between A and B pin at indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B) pins.

Note 4: Per TTL driven input ($V_{IN} = 3.15\text{V}$, control inputs only). A and B pins do not contribute to I_{CC} .

Note 5: All typical values are at $V_{CC} = 5.0\text{V}$, $T_A = 25^\circ\text{C}$.

AC Electrical Characteristics

Symbol	Parameter	V _{CC} (V)	74LVX3L383			Units
			T _A = −40°C to +85°C C _L = 50 pF			
			Min	Typ (Note 5)	Max	
t _{PLH} t _{PHL}	Data Propagation Delay A _n to B _n or B _n to A _n (Note 6)	4.75			0.25	ns
t _{PLH} t _{PHL}	Switch Exchange Time BX to A _n or B _n	4.75	1.5		6.5	ns
t _{PZL} t _{PZH}	Switch Enable Time BE to A _n , B _n	4.75	1.5		6.5	ns
t _{PLZ} t _{PHZ}	Switch Disenable Time BE to A _n , B _n	4.75	1.5		5.5	ns

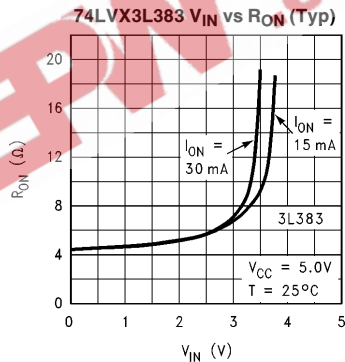
Note 5: All typical values are at V_{CC} = 5.0V, T_A = 25°C.

Note 6: This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the On resistance of the switch and the load capacitance. The time constant for the switch and alone is of the order of 0.25 ns for 50 pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

Capacitance (Note)

Symbol	Parameter	Typ	Max	Units	Conditions
C _{IN}	Control Input Capacitance	4	6	pF	V _{CC} = 5.0V
C _{I/O} (OFF)	Input/Output Capacitance	9	13	pF	V _{CC} = 5.0V

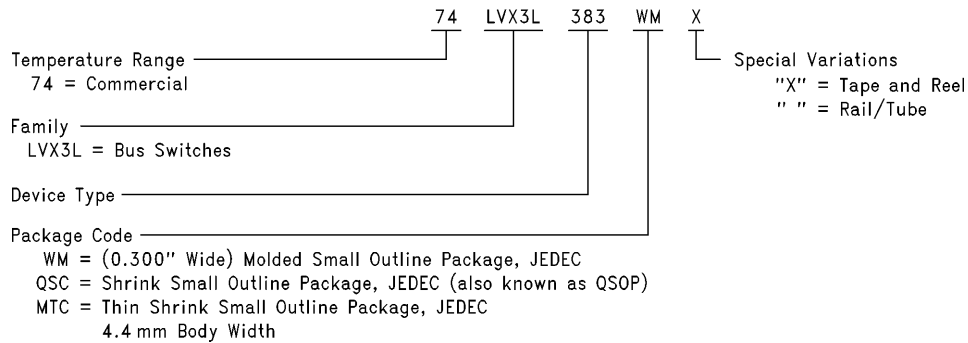
Note: Capacitance is characterized but not tested.



TL/F/11652-4

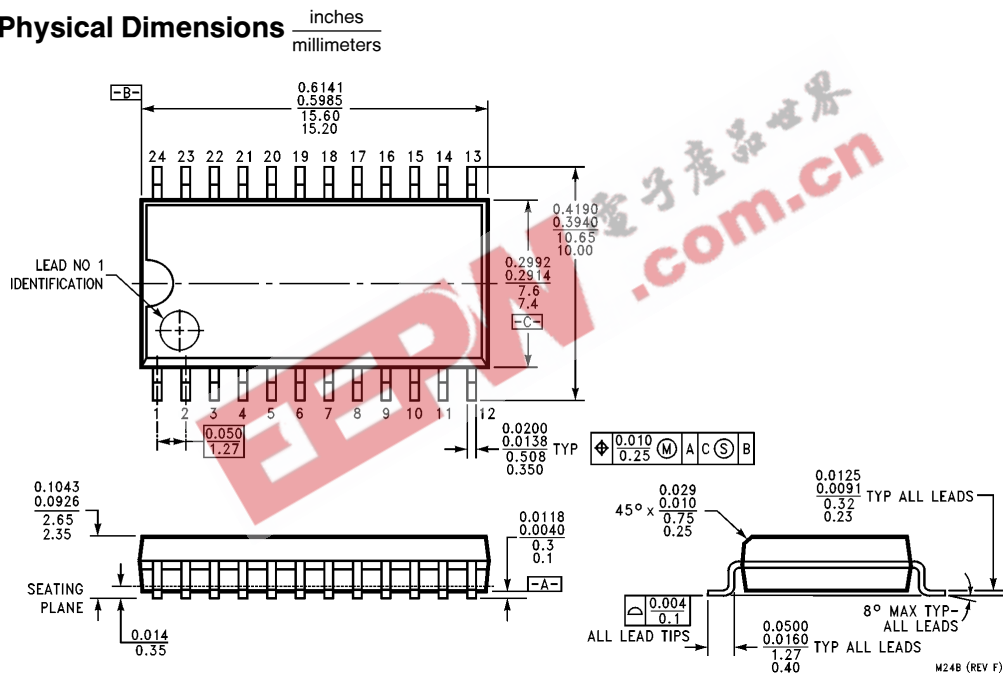
74LVX3L383 Ordering Information

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:



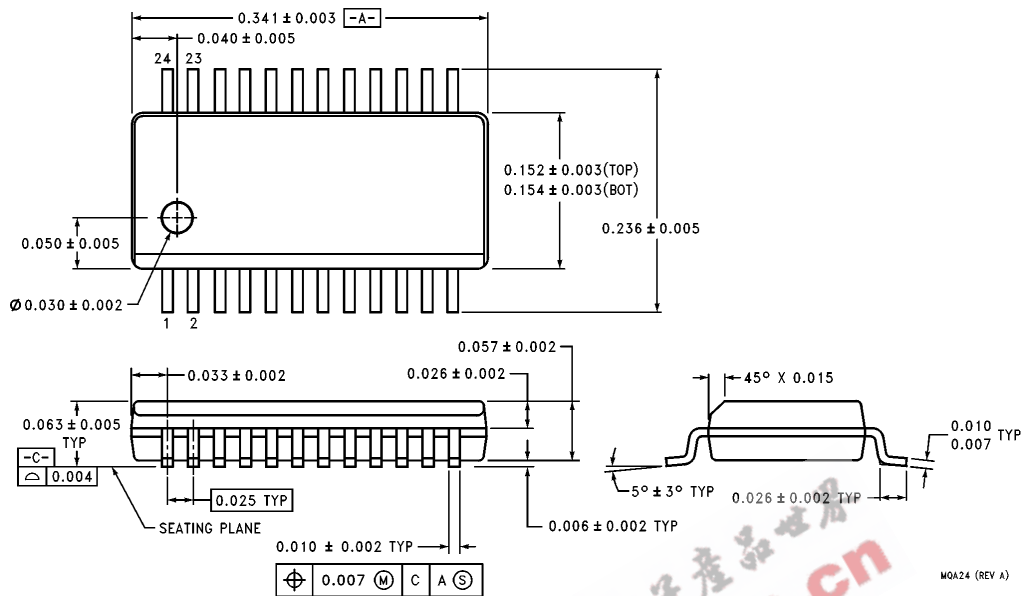
TL/F/11652-5

Physical Dimensions



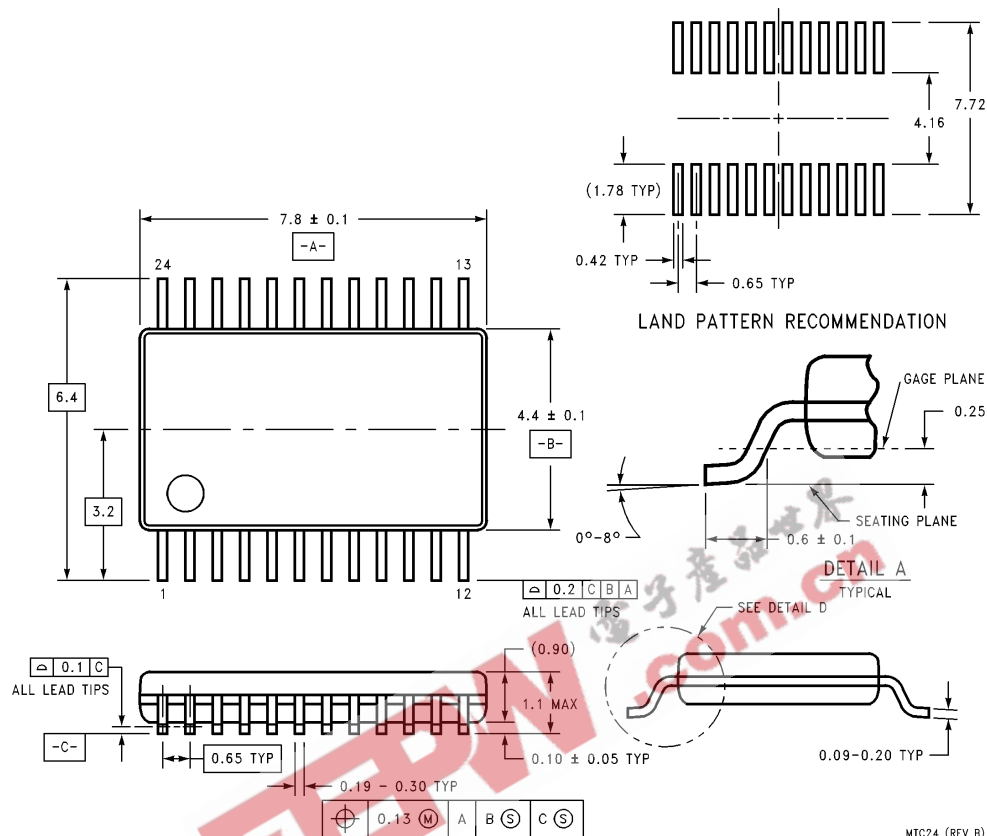
24-Lead (0.300" Wide) Small Outline Package
Order Number 74LVX3L383WM or 74LVX3L383WMX
NS Package Number M24B

Physical Dimensions inches (Continued)



24-Lead (0.150" Wide) Shrink Small Outline Package, JEDEC (QSC)
(also known as QSOP)
Order Number 74LVX3L383QSC or 74LVX3L383QSCX
NS Package Number MQA24

MQA24 (REV A)

Physical Dimensions inches (Continued)

24-Lead Thin Small Outline Package, JEDEC
Order Number 74LVX3L383MTC or 74LVX3L383MTCX
NS Package Number MTC24

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



National Semiconductor Corporation
Americas
 Tel: 1(800) 272-9959
 Fax: 1(800) 737-7018
 Email: support@nsc.com

<http://www.national.com>

National Semiconductor Europe

Fax: +49 (0) 180-530 85 86
 Email: europe.support@nsc.com
 Deutsch Tel: +49 (0) 180-530 85 85
 English Tel: +49 (0) 180-532 78 32
 Français Tel: +49 (0) 180-532 93 58
 Italiano Tel: +49 (0) 180-534 16 80

National Semiconductor Southeast Asia

Fax: (652) 2376 3901
 Email: sea.support@nsc.com

National Semiconductor Japan Ltd.

Tel: 81-3-5620-7561
 Fax: 81-3-5620-6179